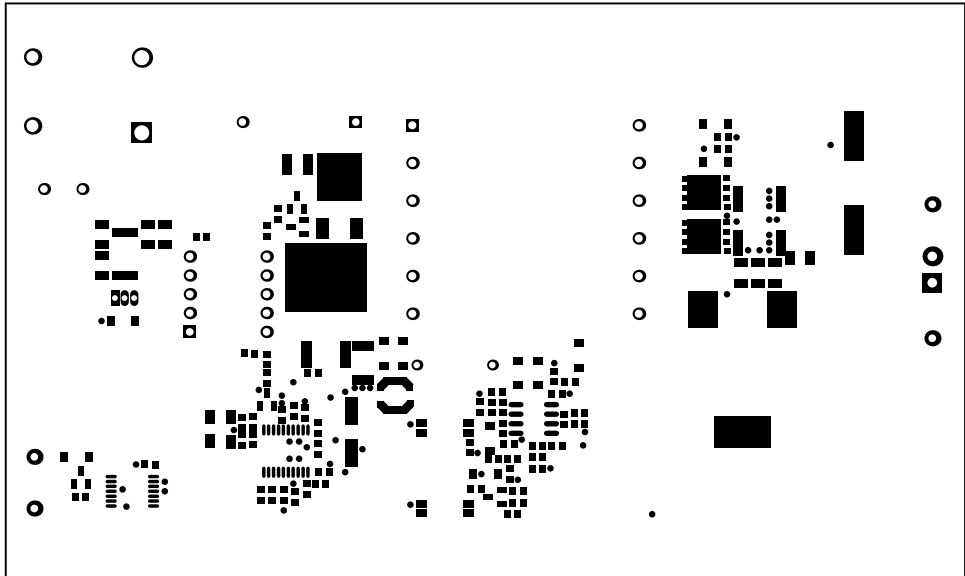
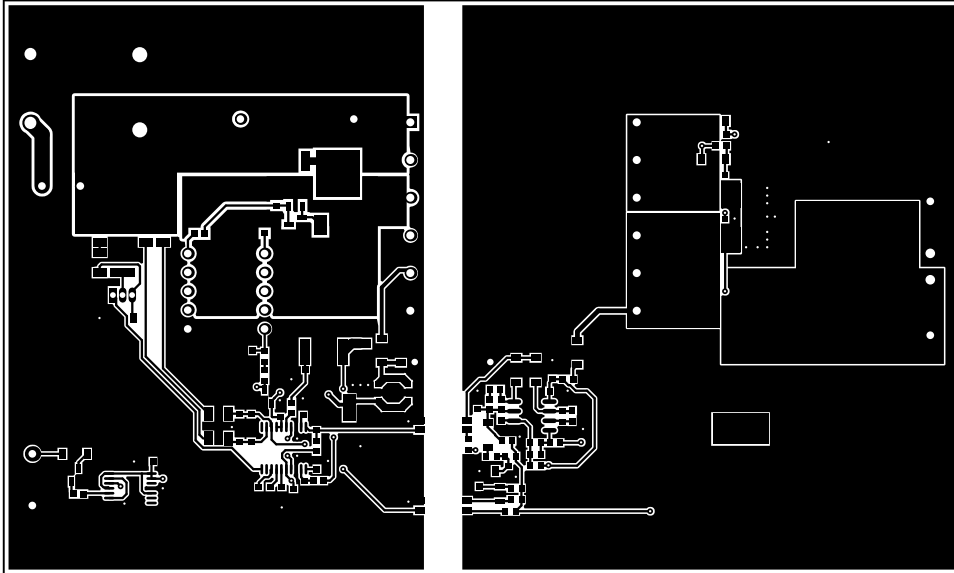


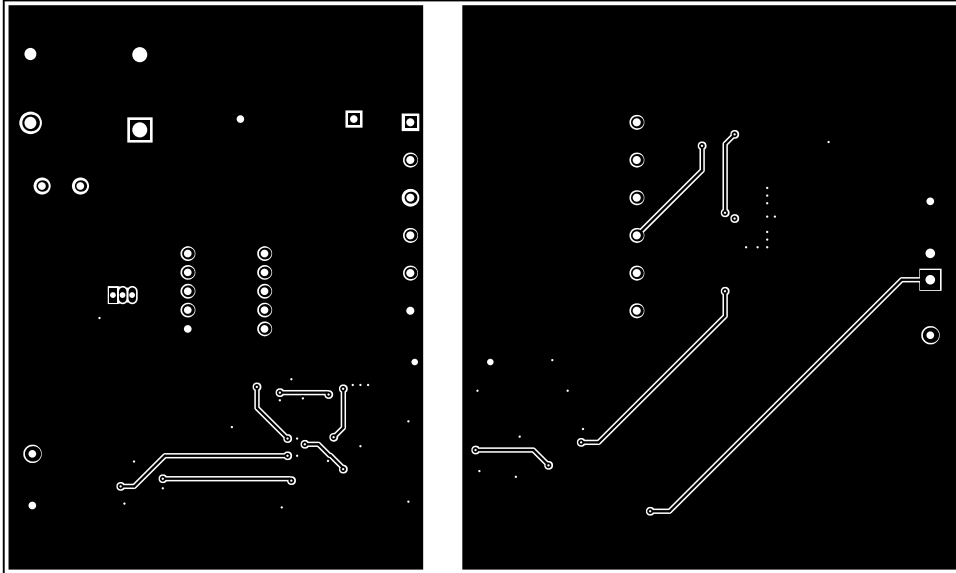
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP7413	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay			
PLOT NAME = Top Overlay	GENERATED : 1/16/2014	6:58:08 AM	TEXAS INSTRUMENTS



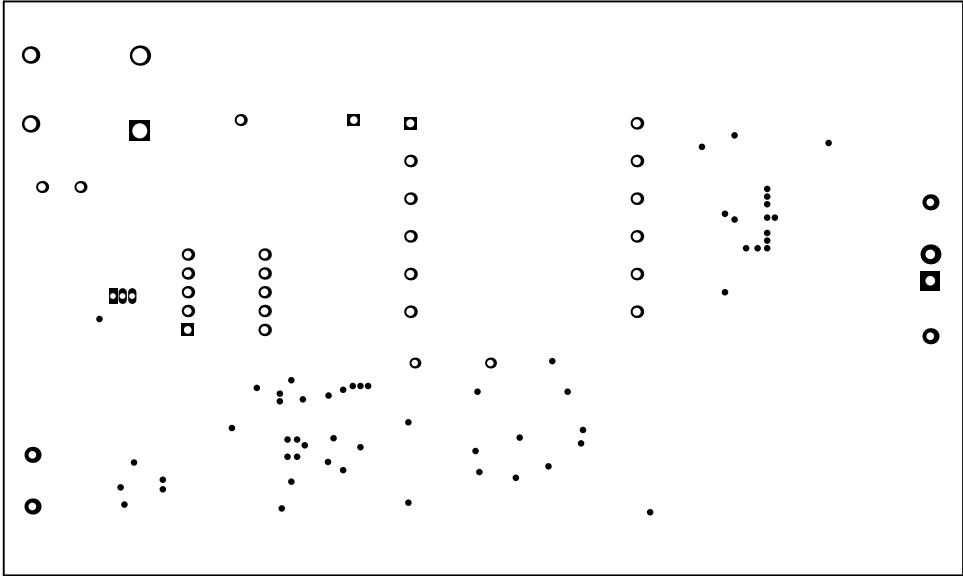
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP7413	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Top Solder			
PLOT NAME = Top Solder Mask	GENERATED : 1/16/2014 6:58:09 AM	TEXAS INSTRUMENTS	



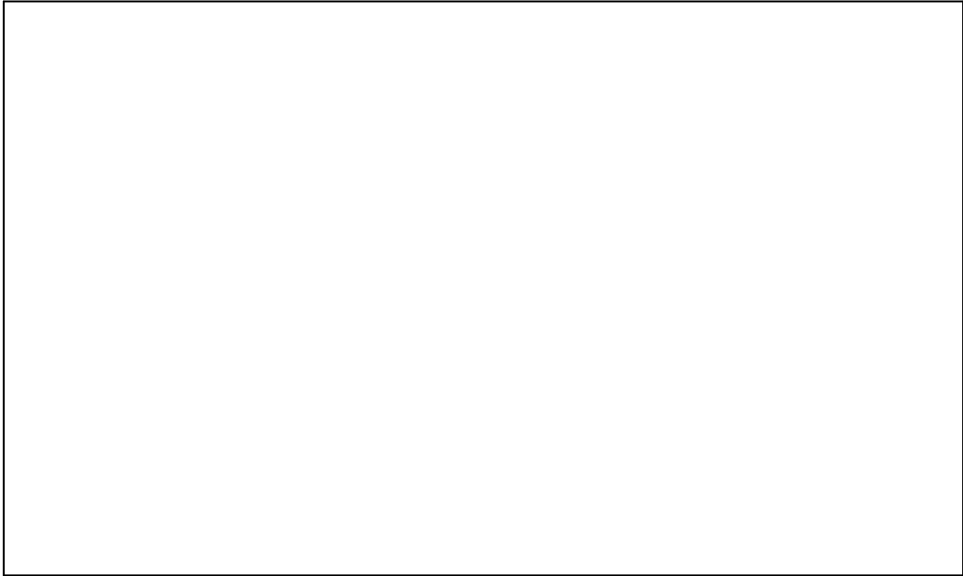
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP7413	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Top Layer			
PLOT NAME = Top Layer	GENERATED : 1/16/2014 6:58:10 AM	TEXAS INSTRUMENTS	



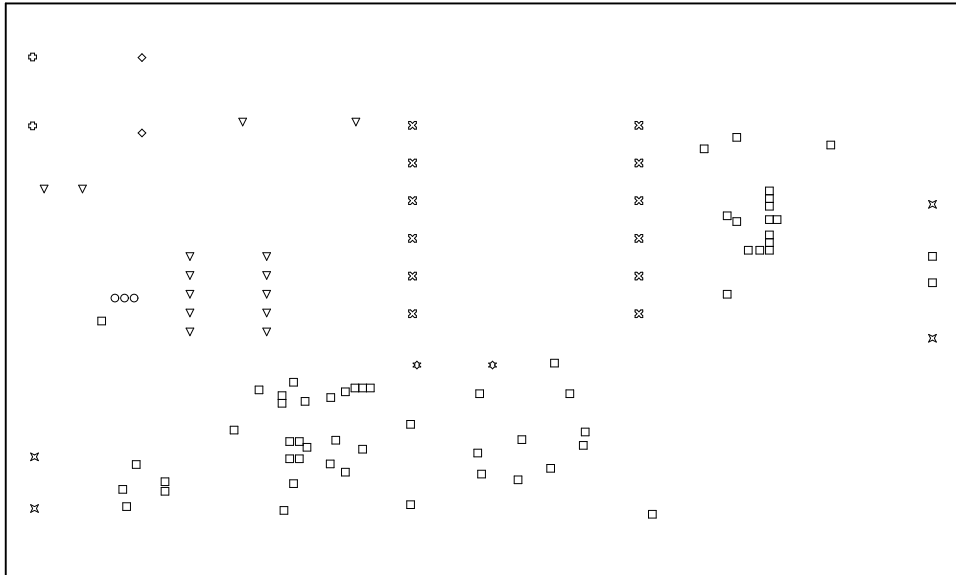
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP7413	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer			
PLOT NAME = Bottom Layer	GENERATED : 1/16/2014 6:58:11 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP7413	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder			
PLOT NAME = Bottom Solder Mask	GENERATED : 1/16/2014 6:58:11 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP7413	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay			
PLOT NAME = Bottom Overlay	GENERATED : 1/16/2014 6:58:12 AM	TEXAS INSTRUMENTS	



Symbol	Hit Count	Tool Size	Plated	Hole Type
□	57	12mil (0.305mm)	PTH	Round
○	3	29.528mil (0.75mm)	PTH	Round
*	2	33.465mil (0.85mm)	PTH	Round
▽	14	39.37mil (1mm)	PTH	Round
×	4	40mil (1.016mm)	PTH	Round
⊗	12	42mil (1.067mm)	PTH	Round
□	2	50mil (1.27mm)	PTH	Round
⊕	2	63mil (1.6mm)	PTH	Round
◇	2	78.74mil (2mm)	PTH	Round
	<b>98 Total</b>			

Drill Table

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP7413	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing			
PLOT NAME = Drill Drawing	GENERATED : 1/16/2014 6:58:13 AM	TEXAS INSTRUMENTS	



← 1000 (mil) →

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP7413	REV: B	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions			
PLOT NAME = Board Dimensions	GENERATED : 1/16/2014 6:58:14 AM	TEXAS INSTRUMENTS	



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